

## Product Description

- 100% Brand new and high quality!!
- Rosin flux is used to facilitate soldering.
- It cleans and prevents metal oxidation which allows solder to create strong, long lasting mechanical and electrical bonds.
- It also acts as a wetting agent, increasing the flow of solder and the efficiency of the soldering process.
- Perfect for mobile phones, PC cards and other sophisticated electronic chip-level flux welding.

## Specifications

Product:BST-706

Melting point:138°C

Weight:500g

Ingredients:Sn99%,Cu0.7%,Ag0.3%



**SOLDER PASTE**

**Lead-free medium temperature**

**BEST 倍思特 SOLDER PASTE**

MODEL: BST-706  
Alloy: Sn42/Bi58  
Shelf Life: 6 months  
Net Weight: 500g

**PRECISION ELECTRONIC REPAIR BEST 倍思特 SOLDER PASTE BGA植锡膏**

- Low residue 低残留物
- Cold storage 低温存储
- Mid-melting point 中温熔点
- Even solder joints 焊点均匀

CE  
MADE IN CHINA

**500g**

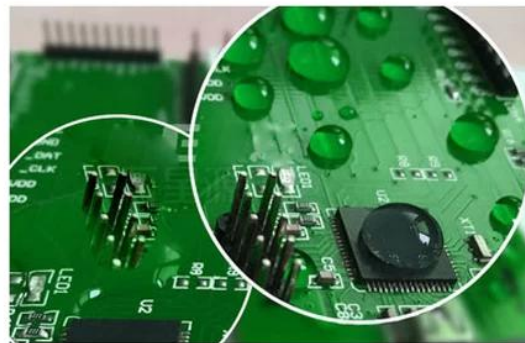
Low residue / Rapid welding / lead free / Solder spot bright

## Product Usage

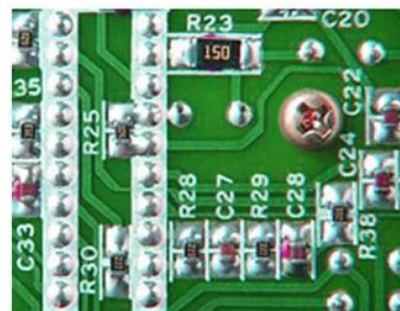
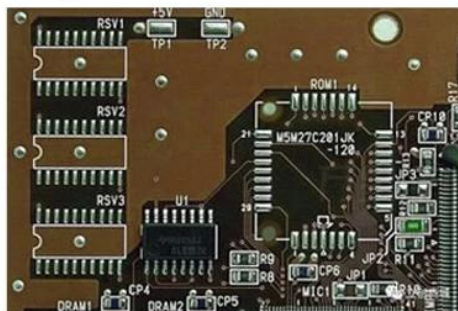


MODEL	BST-706
SHELF LIFE	6 months
INGREDIENT	Sn42/Bi58
WEIGHT	500g
MELTING POINT	138°C

Having a large insulation resistance does not corrode the PCB, and the requirements for no-cleaning can be achieved.



High impedance, full and bright solder, low residue



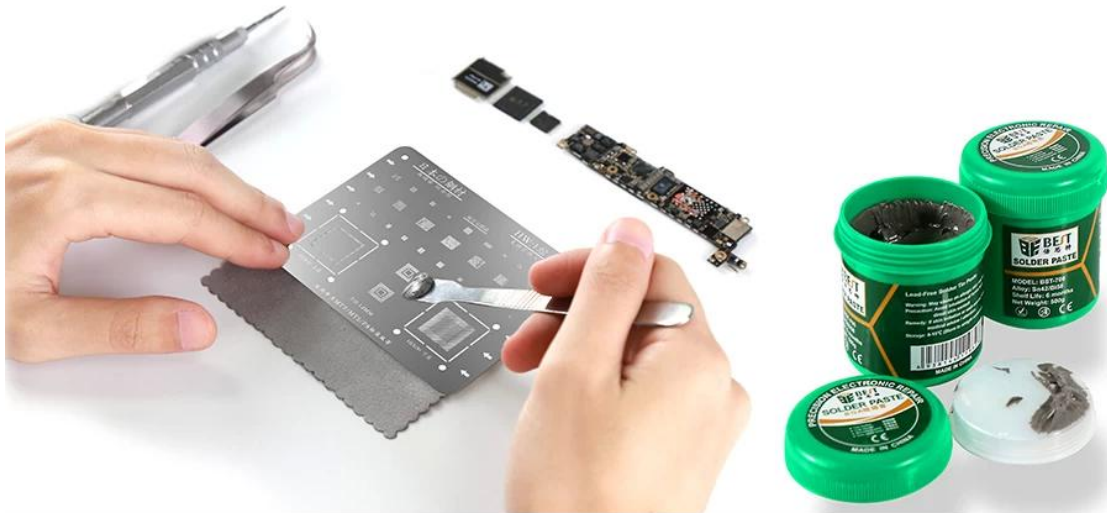
## Welding requirements for a wide range of products





## TESTING EFFECT

UNIFORM SOLDER JOINT  
MEDIUM TEMPERATURE MELTING POINT



## PRODUCT SIZE



63.0MM



52MM

75MM

